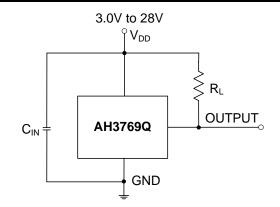


# **Typical Applications Circuit**



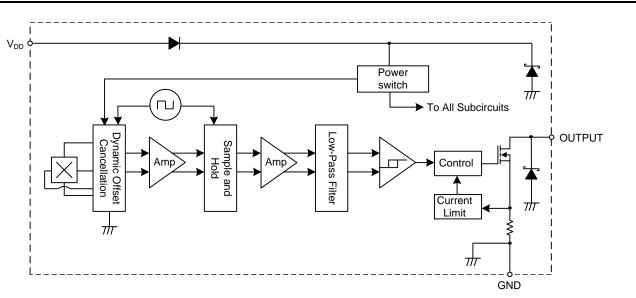
Note: 4. C<sub>IN</sub> is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. RL is the pull-up resistor.

# **Pin Descriptions**

Package: SOT23 and SIP-3

Pin Number	Pin Name	Function
1	V <sub>DD</sub>	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

# **Functional Block Diagram**





## Absolute Maximum Ratings (Notes 5 & 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit	
V <sub>DD</sub>	Supply Voltage (Note 6)		32	V	
V <sub>DDR</sub>	Reverse Supply Voltage (Note 6)		-32	V	
V <sub>OUT_MAX</sub>	Output Off Voltage (Note 6)		32	V	
I <sub>OUT</sub>	Continuous Output Current		60	mA	
IOUT_R	Reverse Output Current	-50	mA		
В	Magnetic Flux Density	Unlimited	•		
D-	Package Power Dissipation	SIP-3	550	mW	
PD	Fackage Fower Dissipation	SOT23	230		
Ts	Storage Temperature Range		-65 to +165	°C	
TJ	Maximum Junction Temperature	+150	°C		
ESD HBM	Electros Static Discharge Withstand - Human Body Model (HMI	8	kV		
ESD MM	Electros Static Discharge Withstand - Machine Model (MM)	800	V		
ESD CDM	Electros Static Discharge Withstand - Charged Device Model (C	CDM)	2	kV	

Notes: 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. The absolute maximum V<sub>DD</sub> of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

## Recommended Operating Conditions (@T<sub>A</sub> = -40°C to +150°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>DD</sub>	Supply Voltage	Operating	3.0 to 28	V
TA	Operating Temperature Range	Operating	-40 to +150	°C

### Electrical Characteristics (Notes 7 & 8) (@TA = -40°C to +150°C, VDD = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Vout_on	Output On Voltage	$I_{OUT} = 20 \text{mA}, \text{B} > B_{op}$	-	0.2	0.4	V
I <sub>LKG</sub>	Output Leakage Current (when output is off)	$V_{OUT} = 28V, B < B_{rp}, Output off$	-	<0.1	10	μA
I <sub>DD</sub>	Supply Current	Output open, T <sub>A</sub> = +25°C	-	3	3.5	mA
		Output open, T <sub>A</sub> = -40°C to +150°C	-	-	4	mA
		V <sub>DD</sub> = -18V, T <sub>A</sub> = +25°C	-	0.6	-	μA
	Deverse Supply Current	V <sub>DD</sub> = -18V, T <sub>A</sub> = -40°C to +150°C	-	0.6	1,500	μA
I <sub>DD_R</sub>	Reverse Supply Current	V <sub>DD</sub> = -28V, T <sub>A</sub> = +25°C	-	1.6	-	μA
		V <sub>DD</sub> = -28V, T <sub>A</sub> = -40°C to +150°C	-	1.6	2,500	μA
tp on	Device Power-On Time (start-up time)	$V_{DD} \ge 3V, B \ge B_{op}$ (Note 7)	-	10		μs
f <sub>c</sub>	Chopping Frequency	$V_{DD} \ge 3V$	-	800	-	kHz
t <sub>d</sub>	Response Time Delay (time from magnetic threshold reached to the start of the output rise or fall)	(Note 9)	-	3.75	-	μs
tr	Output Rising Time (external pull-up resistor R⊾ and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.2	1	μs
t <sub>f</sub>	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.1	1	μs
IOCL	Output Current Limit	B > B <sub>op</sub> , (Note 10 )	30	-	55	mA
Vz	Zener Clamp Voltage	I <sub>DD</sub> = 5mA	28	-	-	V

7. When power is initially turned on, Vod must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

 Typical values are defined at T<sub>A</sub> = +25°C, V<sub>DD</sub> = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

9. Guaranteed by design, process control and characterization. Not tested in production.

10. The device will limit the output current IOUT to current limit of IOCL.

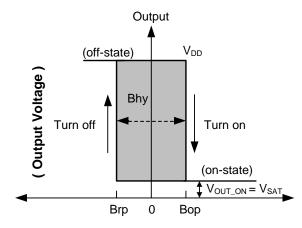


# Magnetic Characteristics (Notes 11 & 12) (T<sub>A</sub> = -40°C to +150°C, V<sub>DD</sub> = 3.0V to 28V, unless otherwise specified.)

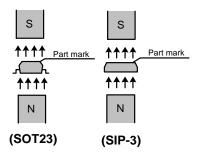
				(	1mT=10 0	Gauss)
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Bops (South pole to part marking side for	Operation Point	$V_{DD} = 12V, T_A = +25^{\circ}C$	-	220	-	
SOT23 and SIP-3 packages)	Operation Point	$T_A = -40^{\circ}C \text{ to } +150^{\circ}C$	170	220	250	
B <sub>rps</sub> (North pole to part marking side for	Release Point	$V_{DD} = 12V, T_A = +25^{\circ}C$	-	-220	-	Gauss
SOT23 and SIP-3 packages)	Release Foint	$T_A = -40^{\circ}C \text{ to } +150^{\circ}C$	-250	-220	-170	Gauss
	Hysteresis (Note 13)	$V_{DD} = 12V, T_A = +25^{\circ}C$	-	340	-	
B <sub>hy</sub> ( B <sub>opx</sub>  - B <sub>rpx</sub>  )	Tysteresis (Note 13)	$T_A = -40^{\circ}C \text{ to } +150^{\circ}C$	340	440	500	

Notes: 11. When power is initially turned on, VDD must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

12. Typical values are defined at T<sub>A</sub> = +25°C, V<sub>DD</sub> = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization. 13. Maximum and minimum hysteresis is guaranteed by design, process control and characterization.









Brp

Brp

150

Brp

150

175

175

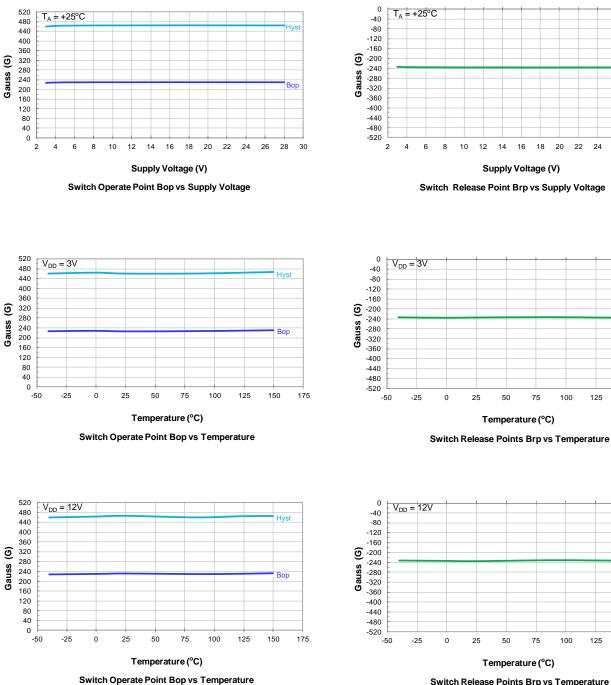
24 26 28 30

125

125

# **Typical Operating Characteristics**

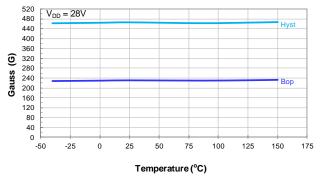
### Output Switch Operate and Release Points (Magnetic Thresholds) – Bop and Brp



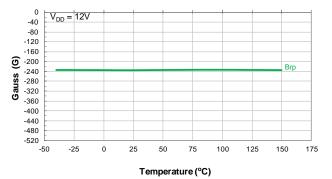


# **Typical Operating Characteristics**

## Output Switch Operate and Release Points (Magnetic Thresholds) - Bop and Brp (cont.)

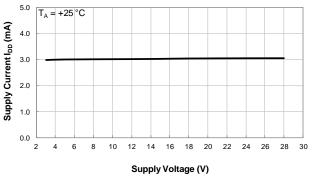


Switch Operate Point Bop vs Temperature

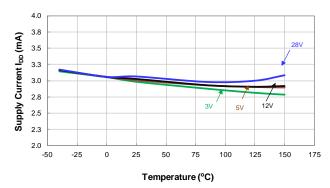




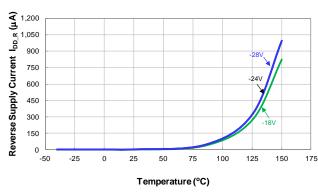
## **Supply Current**



Supply Current vs Supply Voltage

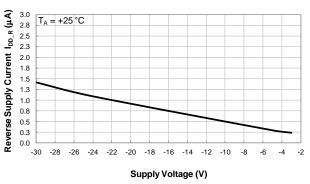


Supply Current vs Temperature



Reverse Supply Current vs Temperature

#### **Reverse Supply Current**



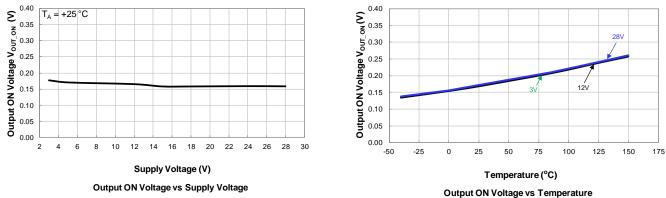
Reverse Supply Current vs Supply Voltage



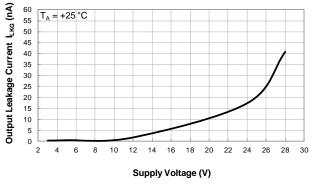


# Typical Operating Characteristics (cont.)

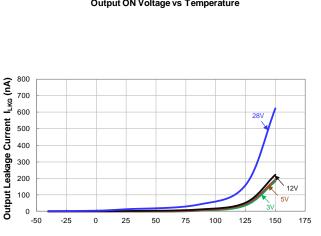
### **Output Switch On Voltage**



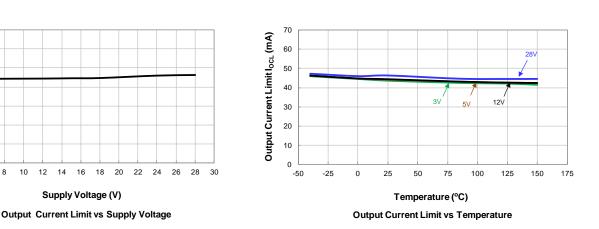
#### **Output Switch Leakage Current**



Output Leakage Current vs Supply Voltage



Temperature (°C) Output Leakage Current vs Temperature



### **Output Current Limit**

T<sub>A</sub> = +25 °C

70

60

50

40

30

20

10

0

2 4 6 8

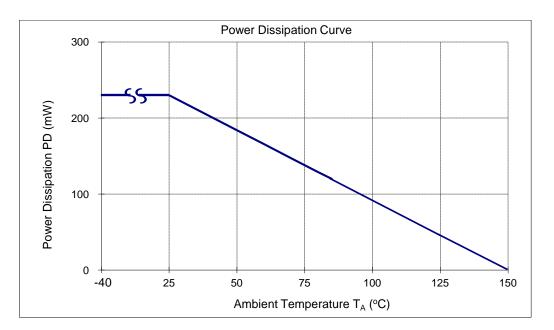
Output Current Limit I<sub>ocL</sub> (mA)



# **Thermal Performance Characteristics**

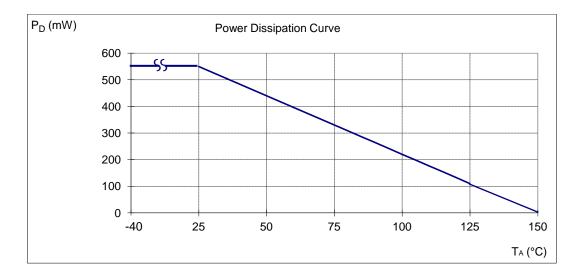
### (1) Package type: SOT23

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P <sub>D</sub> (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



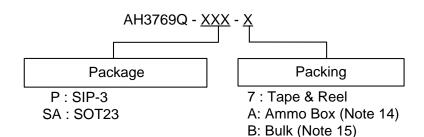
#### (2) Package type: SIP-3

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P <sub>D</sub> (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0





# **Ordering Information**

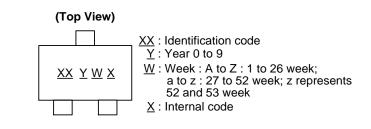


	Packago	Package Bulk 7" Tape an		d Reel Ammo Box		io Box		
Part Number	Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3769Q-P-A	Р	SIP-3	NA	NA	NA	NA	4,000/Box	-A
AH3769Q-P-B	Р	SIP-3	1,000	-B	NA	NA	NA	NA
AH3769Q-SA-7	SA	SOT23	NA	NA	3,000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 Spread Lead. 15. Bulk is for SIP-3 Straight Lead.

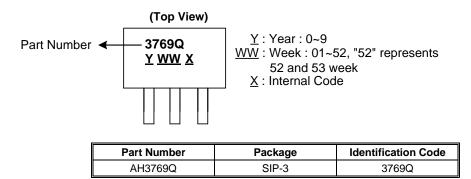
# **Marking Information**

### (1) Package Type: SOT23



Part Number	Package	Identification Code
AH3769Q	SOT23	WU

#### (2) Package Type: SIP-3

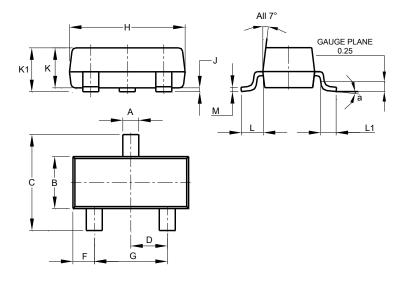




# Package Outline Dimensions (All dimensions in mm.)

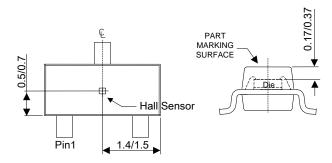
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### (1) Package Type: SOT23



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
К	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а		8°	
All	Dimens	ions in	mm

Min/Max



Sensor Location - To be updated

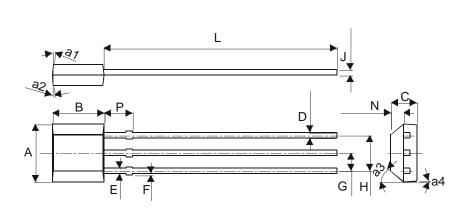


# Package Outline Dimensions (cont.) (All dimensions in mm.)

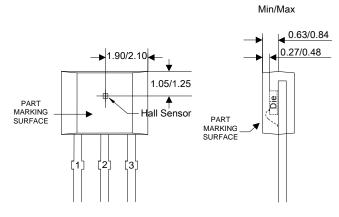
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

## (2) Package Type: SIP-3 Bulk

Sensor location to be added



	SIP-3 (Bu	lk)
Dim	Min	Max
Α	3.9	4.3
a1	5°	Тур
a2	5°	Тур
a3	45°	' Тур
a4	3°	Тур
В	2.8	3.2
С	1.40	1.60
D	0.33	0.432
ш	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
Ν	0.63	0.84
Р	1.55	-
All Di	mension	s in mm



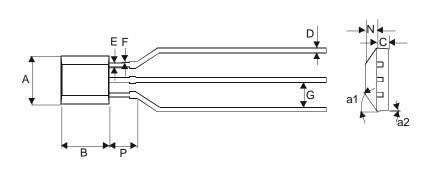
Sensor Location - To be updated



## Package Outline Dimensions (cont.) (All dimensions in mm.)

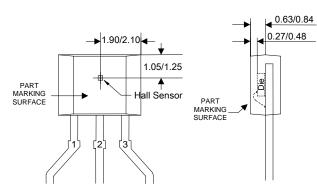
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

#### (3) Package Type: SIP-3 Ammo Pack



SIP-	3 (Amm	o Pack)
Dim	Min	Max
Α	3.9	4.3
a1	45	5° Тур
a2	3	° Тур
В	2.8	3.2
С	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
Ν	0.63	0.84
Р	1.55	-
All Di	mensior	ns in mm



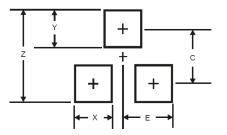


Sensor Location - To be updated

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

#### (1) Package Type: SOT23



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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